

This listing of claims will replace all prior versions, and listings, of claims in this patent application.

**Listing of Claims:**

1.-16. (canceled)

17. (currently amended) An electrotransport device comprising:  
a reservoir and a non-conductive housing for the reservoir ~~of the electrotransport device~~  
that comprises a substantially flexible electrically conductive element integrally molded within the non-conductive housing,

wherein a first portion of the conductive element is within the ~~reservoir~~ non-conductive housing and a second portion of the element is disposed on the outside of the ~~reservoir~~ non-conductive housing and extends therefrom,

and wherein a substantially liquid and moisture-impermeable bond is created between the material forming the ~~reservoir~~ non-conductive housing and the conductive element.

18. (currently amended) The electrotransport device of claim 17, wherein the ~~reservoir~~ non-conductive housing is a single integral component.

19. (currently amended) The electrotransport device of claim 18, wherein the electrotransport device is manufactured without the fabrication of openings or other passages through the ~~reservoir~~ non-conductive housing.

20. (previously presented) The electrotransport device of claim 17, wherein the conductive element comprises a substantially planar member.

21. (previously presented) The electrotransport device of claim 17, wherein the conductive element includes a base member having a conductive coating disposed thereon.